

Electronic Acknowledgement Receipt

EFS ID:	1131739
Application Number:	10749096
Confirmation Number:	3177
Title of Invention:	MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE HAVING AN ELECTRICAL SHIELDING PORTION
First Named Inventor:	Rafael Reif
Customer Number:	22494
Filer:	Christopher S. Daly/Trish McHugh
Filer Authorized By:	Christopher S. Daly
Attorney Docket Number:	MIT-136DUS
Receipt Date:	28-JUL-2006
Filing Date:	30-DEC-2003
Time Stamp:	13:55:25
Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		TO_PTO_DEFICIENCY_LETTER.pdf	87436	yes	3

	Multipart Description		
	Doc Desc	Start	End
	Miscellaneous Incoming Letter	1	1
	Miscellaneous Incoming Letter	2	3

Warnings:

Information:

Total Files Size (in bytes):

87436

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.